Transient Voltage Suppression Diodes: TP5.0SMDJ Serie

SMD Type 5000 W

Features

- 1. High reliability application and automotive grade AEC Q101 qualified
- 2. 5000W peak pulse power capability with a 10/1000 μs waveform, repetitive rate (duty cycle): 0.01%
- 3. Low leakage current
- 4. Excellent clamping capability
- 5. RoHS compliant
- 6. Very fast response time
- 7. ESD protection of data lines in accordance with IEC 61000-4-2,30kV(Air),30kV(Contact)

Recommended Applications

- 1. Telecommunication
- 2. Computer
- 3. Industrial device
- 4. Consumer electronic device
- 5. Automotive

Mechanical Data

- 1. Case: DO-214AB (SMC), molded plastic meets
- 2. Epoxy : UL 94V-0 rate flame retardant
- 3. Terminal: Solderable per MIL-STD-750, Method 2026
- 4. Polarity: Color band denotes cathode end











SMD Type 5000 W

Structures and Dimensions



T	
P2	
$\square - \square$	-
	Q2
P1	

SMC / DO-214AB			
Dimension	Millimeters		
Dimensions	Min	Max	
Α	6.60	7.15	
В	2.75	3.27	
С	5.55	6.22	
D	7.75	8.13	
E	1.98	2.80	
F	0.15	0.31	
G	0.75	1.52	
Н	0.00	0.30	

SMC / DO-214AB		
Dimensions Millimete		
P1	9.90	
P2	3.84	
Q1	3.03	
Q2	3.82	

■ Maximum Rating (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation at TA=25 $^{\circ}$ C by 10/1000µs waveform (Note1、2)	P _{PPM}	С	W
Peak forward surge current, 8.3ms single half sine wave on rated load (Note 3)	I _{FSM}	300	А
Power dissipation on infinite heatsink at T∟=75°C	PD	6.5	W
Maximum instantaneous forward voltage at 100A for unidirectional only	VF	3.5	V
Typical thermal resistance junction to ambient		75	°C/W
Typical thermal resistance junction to lead	Rej∟	15	°C/W
Operating junction and storage temperature range	Tj, Tstg	-65~+150	°C

Notes : (1) Non-repetitive current pulse, per Fig. 3 and derated above TA=25 $^\circ\!\!{\rm C}$ $\,$ per Fig. 2

(2) Mounted on copper pad area of 0.31" x 0.31" (8.0 x 8.0mm) to each terminal

(3) Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum

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■ Electrical Characteristics (T_A=25[°]C unless otherwise noted)

		•								
Part No. (Uni)	Part No. (Bi)	Reverse Stand off Voltage VRWM	Brea Vol VBR	akage tage @ IT Max(V)	Test Current	Maximum Clamping Voltage VC @ lpp	Maximum Peak Pulse Current	Maximum Reverse Leakage IR @VRWM	Mar Cc	king ode Bi
		(V)	wiiii (v)		11(11//)	VO(V)	199(77)	Π (μ/ ()	On	
TP5.0SMDJ11A	TP5.0SMDJ11CA	11	12.2	13.5	1	18.2	274.73	800	5PDX	5BDX
TP5.0SMDJ12A	TP5.0SMDJ12CA	12	13.3	14.7	1	19.9	251.26	800	5PDZ	5BDZ
TP5.0SMDJ13A	TP5.0SMDJ13CA	13	14.4	15.9	1	21.5	232.56	500	5PEE	5BEE
TP5.0SMDJ14A	TP5.0SMDJ14CA	14	15.6	17.2	1	23.2	215.52	200	5PEG	5BEG
TP5.0SMDJ15A	TP5.0SMDJ15CA	15	16.7	18.5	1	24.4	204.92	100	5PEK	5BEK
TP5.0SMDJ16A	TP5.0SMDJ16CA	16	17.8	19.7	1	26	192.31	50	5PEM	5BEM
TP5.0SMDJ17A	TP5.0SMDJ17CA	17	18.9	20.9	1	27.6	181.16	20	5PEP	5BEP
TP5.0SMDJ18A	TP5.0SMDJ18CA	18	20	22.1	1	29.2	171.23	10	5PER	5BER
TP5.0SMDJ19A	TP5.0SMDJ19CA	19	21.1	23.3	1	30.8	162.34	10	5PET	5BET
TP5.0SMDJ20A	TP5.0SMDJ20CA	20	22.2	24.5	1	32.4	154.32	5	5PEV	5BEV
TP5.0SMDJ22A	TP5.0SMDJ22CA	22	24.4	26.9	1	35.5	140.85	5	5PEX	5BEX
TP5.0SMDJ24A	TP5.0SMDJ24CA	24	26.7	29.5	1	38.9	128.53	2	5PEZ	5BEZ
TP5.0SMDJ26A	TP5.0SMDJ26CA	26	28.9	31.9	1	42.1	118.76	2	5PFE	5BFE
TP5.0SMDJ28A	TP5.0SMDJ28CA	28	31.1	34.4	1	45.4	110.13	2	5PFG	5BFG
TP5.0SMDJ30A	TP5.0SMDJ30CA	30	33.3	36.8	1	48.4	103.31	2	5PFK	5BFK
TP5.0SMDJ33A	TP5.0SMDJ33CA	33	36.7	40.6	1	53.3	93.81	2	5PFM	5BFM
TP5.0SMDJ36A	TP5.0SMDJ36CA	36	40	44.2	1	58.1	86.06	2	5PFP	5BFP
TP5.0SMDJ40A	TP5.0SMDJ40CA	40	44.4	49.1	1	64.5	77.52	2	5PFR	5BFR
TP5.0SMDJ43A	TP5.0SMDJ43CA	43	47.8	52.8	1	69.4	72.05	2	5PFT	5BFT
TP5.0SMDJ45A	TP5.0SMDJ45CA	45	50	55.3	1	72.7	68.78	2	5PFV	5BFV
TP5.0SMDJ48A	TP5.0SMDJ48CA	48	53.3	58.9	1	77.4	64.60	2	5PFX	5BFX
TP5.0SMDJ51A	TP5.0SMDJ51CA	51	56.7	62.7	1	82.4	60.68	2	5PFZ	5BFZ
TP5.0SMDJ54A	TP5.0SMDJ54CA	54	60	66.3	1	87.1	57.41	2	5PGE	5BGE
TP5.0SMDJ58A	TP5.0SMDJ58CA	58	64.4	71.2	1	93.6	53.42	2	5PGG	5BGG



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■ Rate and Characteristic Curve (T_A=25°C unless otherwise noted)



Fig.3 - Pulse Waveform







Fig.4 - Typical Junction Capacitance



Fig.6 - Maximum Non-Repetitive Surge Current



IR-reflow soldering profile



LEAD(Pb)-FREE SOLDER(SnAgCu) REFLOW PROFILE ATTRIBUTES				
PROFILE ATTRIBUTE	PROFILE ATTRIBUTE			
Peak Reflow Temperature	260(+8/-8) °℃			
Time within 5°C of Peak Temperature	30s max			
Liquidus Temperature of Solder	217 ℃			
Cool Down Rate	6 °C/s max			
Time above Liquidus	60s to 150s			
Pre-heat Temperature Range	150℃ to 200℃			
Pre-heat Dwell Time	60s to 120s			
Maximum Ramp Rate	3 °C/s max			





Packaging





		DO-214AB		
Item	Symbol	(SMC)		
		Unit:mm		
Carrier width	A0	6.05±0.1		
Carrier length	B0	8.31±0.1		
Carrier depth	K0	2.54±0.1		
Sprocket hole	D0/D1	1.55±0.05		
Sprocket hole position	E	1.75±0.1		
Punch hole position	F	7.5±0.1		
Sprocket hole pitch	P0	4±0.1		
Carrier pitch	P1	8±0.1		
Embossment center	P2	2±0.1		
Tape thickness	t	0.3±0.02		
Tape width	W	16±0.3		

Quantity

Package Type	Reel Size (inch)	Quantity (pcs/reel)
DO-214AB	13	3,000

Warehouse Storage Conditions of product

- Storage Condition:
- 1. Storage Temperature: ≤25 °C
- 2. Relative Humidity: 50%~80%RH
- 3. Keep away from corrosive atmosphere and sunlight.
- Period of Storage: 1 year.